

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Dussinger et al.

Filing Date: May 9, 2001

Examiner: Atkinson, Christopher M.

Serial No.: 09/852,322

Group: 3743

For: INTEGRATED CIRCUIT HEAT PIPE HEAT SPREADER  
WITH THROUGH MOUNTING HOLES

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents  
Washington, D.C. 20231

Sir:

Pursuant to the Duty of Disclosure set forth in 37 CFR 1.56, the materials listed on the enclosed form PTO-1449 are hereby brought to the attention of the Examiner. A copy of each is enclosed.

Item D on the attached PTO-1449 Form is an Engineering Drawing that shows a Japanese language date of H19.2.26, which in English corresponds to February 26, 1998. The drawing contains Japanese characters above that date indicating that this drawing shows, a hole, a lid, and a base. Applicant submits that there is no representation of a heat pipe for spreading heat comprising, a boundary structure including spaced-apart first and second plates that define an enclosed vapor chamber, at least one depression formed in the first plate which projects into the vapor chamber and that is bonded to the second plate, and an opening defined through the at least one depression and the second plate so that the opening is isolated from the vapor chamber, as claimed in the above-identified application.

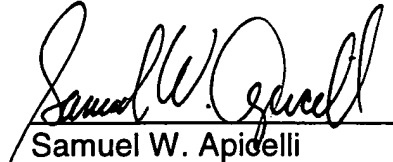
Docket No.: H1799-00071

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The claimed invention is patentable over the enclosed references. No representations are made regarding the references other than those set forth above.

Respectfully submitted,

Date: 2/27/02

  
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